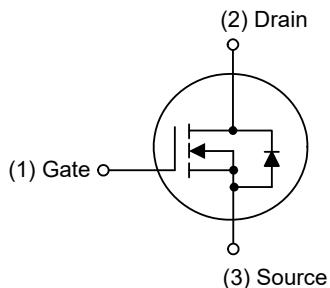
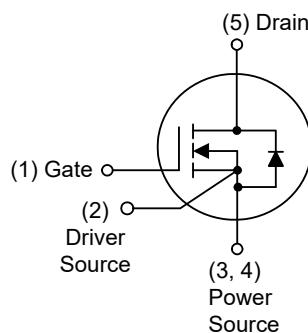


**F30NM65****Power MOSFET****30A, 650V N-CHANNEL  
SUPER-JUNCTION MOSFET****■ DESCRIPTION**

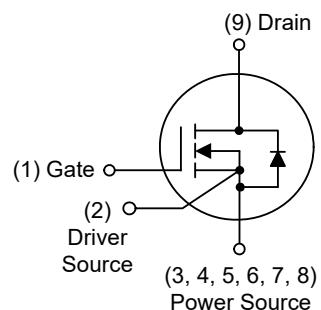
The **UTC F30NM65** is a N-Channel enhancement mode silicon gate power MOSFET with Fast Body Diode. is designed high voltage, high speed power switching applications such. such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics.

**■ FEATURES**

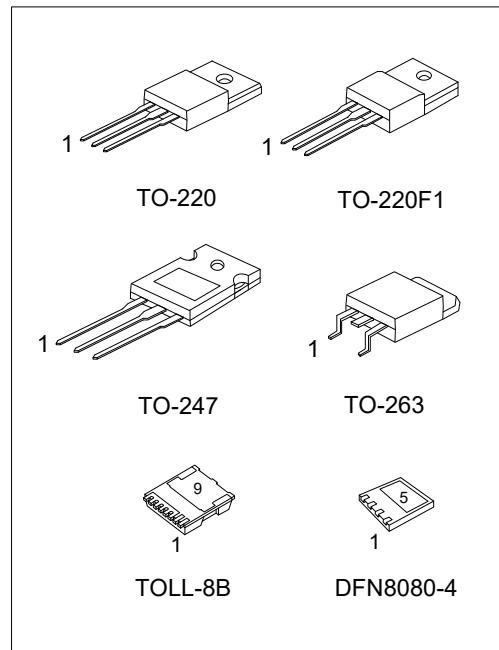
- \*  $R_{DS(ON)} \leq 0.15 \Omega$  @  $V_{GS}=10V$ ,  $I_D=15A$
- \* Fast body diode MOSFET technology
- \* Low switching losses due to reduced Qrr
- \* Single Pulse Avalanche Energy Rated
- \* Fast Switching Speeds
- \* Linear Transfer Characteristics
- \* High Input Impedance
- \* Avalanche energy tested

**■ SYMBOL**TO-220 / TO-220F1  
TO-247 / TO-263

DFN8080-4



TOLL-8B



### ■ ORDERING INFORMATION

| Ordering Number     |                     | Package   | Pin Assignment |   |   |   |   |   |   |   |   | Packing   |
|---------------------|---------------------|-----------|----------------|---|---|---|---|---|---|---|---|-----------|
| Lead Free           | Halogen Free        |           | 1              | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |           |
| F30NM65L-TA3-T      | F30NM65G-TA3-T      | TO-220    | G              | D | S | - | - | - | - | - | - | Tube      |
| F30NM65L-TF1-T      | F30NM65G-TF1-T      | TO-220F1  | G              | D | S | - | - | - | - | - | - | Tube      |
| F30NM65L-TQ2-T      | F30NM65G-TQ2-T      | TO-263    | G              | D | S | - | - | - | - | - | - | Tube      |
| F30NM65L-TQ2-R      | F30NM65G-TQ2-R      | TO-263    | G              | D | S | - | - | - | - | - | - | Tape Reel |
| F30NM65L-T47-T      | F30NM65G-T47-T      | TO-247    | G              | D | S | - | - | - | - | - | - | Tube      |
| F30NM65L-T8B-R      | F30NM65G-T8B-R      | TOLL-8B   | G              | S | S | S | S | S | S | S | D | Tape Reel |
| F30NM65L-K04-8080-R | F30NM65G-K04-8080-R | DFN8080-4 | G              | S | S | S | D | - | - | - | - | Tape Reel |

Note: Pin Assignment: G: Gate D: Drain S: Source

|                    |  |
|--------------------|--|
| <br>F30NM65G-TA3-T | (1) T: Tube, R:Tape Reel<br>(2) TA3: TO-220, TF1: TO-220F1, T47: TO-247,<br>TQ2: TO-263, T8B: TOLL-8B,<br>K04-8080: DFN8080-4<br>(3) G: Halogen Free and Lead Free, L: Lead Free |
|--------------------|--|

### ■ MARKING

| PACKAGE                              | MARKING   |
|--------------------------------------|---|
| TO-220 / TO-220F1<br>TO-247 / TO-263 | <br>Lot Code ←      1      → Date Code<br>L: Lead Free<br>G: Halogen Free |
| DFN8080-4                            | <br>Lot Code ←      → Date Code   |
| TOLL-8B                              | <br>Lot Code ←      1      → Date Code<br>L: Lead Free<br>G: Halogen Free |

■ ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ , unless otherwise specified)

| PARAMETER                          |                        | SYMBOL    | RATINGS    | UNIT             |
|------------------------------------|------------------------|-----------|------------|------------------|
| Drain-Source Voltage               |                        | $V_{DSS}$ | 650        | V                |
| Gate-Source Voltage                |                        | $V_{GSS}$ | $\pm 30$   | V                |
| Drain Current                      | Continuous             | $I_D$     | 30         | A                |
|                                    | Pulsed (Note 2)        | $I_{DM}$  | 60         | A                |
| Avalanche Energy                   | Single Pulsed (Note 3) | $E_{AS}$  | 1188       | mJ               |
| Peak Diode Recovery dv/dt (Note 4) |                        | dv/dt     | 10.8       | V/nS             |
| Power Dissipation                  | TO-220/TO-220F1        | $P_D$     | 40         | W                |
|                                    | TO-263                 |           |            |                  |
|                                    | TO-247                 |           | 145        | W                |
|                                    | TOLL-8B                |           | 210        | W                |
|                                    | DFN8080-4              |           | 70         | W                |
| Junction Temperature               | $T_J$                  |           | +150       | $^\circ\text{C}$ |
| Storage Temperature                | $T_{STG}$              |           | -55 ~ +150 | $^\circ\text{C}$ |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L = 60 \text{ mH}$ ,  $I_{AS} = 6.29\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 30\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

| PARAMETER           |                  | SYMBOL        | RATINGS     | UNIT               |
|---------------------|------------------|---------------|-------------|--------------------|
| Junction to Ambient | TO-220/TO-220F1  | $\theta_{JA}$ | 62.5        | $^\circ\text{C/W}$ |
|                     | TO-263           |               | 40          | $^\circ\text{C/W}$ |
|                     | TO-247           |               | 35 (Note)   | $^\circ\text{C/W}$ |
| Junction to Case    | TO-220/DFN8080-4 | $\theta_{JC}$ | 0.96        | $^\circ\text{C/W}$ |
|                     | TO-220/TO-263    |               | 3.12        | $^\circ\text{C/W}$ |
|                     | TO-220F1         |               | 0.86        | $^\circ\text{C/W}$ |
|                     | TO-247           |               | 0.59 (Note) | $^\circ\text{C/W}$ |
|                     | DFN8080-4        |               | 1.78 (Note) | $^\circ\text{C/W}$ |

Note: Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board; 270°C/W when mounted on min. copper pad.

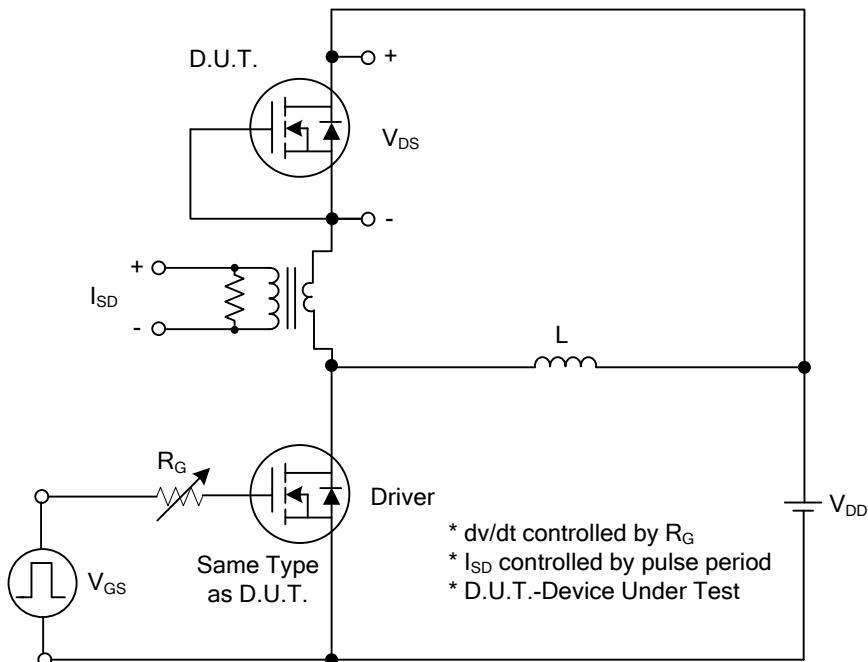
■ ELECTRICAL CHARACTERISTICS ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

| PARAMETER  | SYMBOL                   | TEST CONDITIONS  | MIN | TYP  | MAX  | UNIT          |
|--|--------------------------|--|-----|------|------|---------------|
| <b>OFF CHARACTERISTICS</b>                             |                          |  |     |      |      |               |
| Drain-Source Breakdown Voltage                         | $\text{BV}_{\text{DSS}}$ | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$   | 650 |      |      | V             |
| Drain-Source Leakage Current                           | $I_{\text{DSS}}$         | $V_{DS}=650\text{V}, V_{GS}=0\text{V}$   |     | 10   |      | $\mu\text{A}$ |
| Gate- Source Leakage Current                           | Forward                  | $V_{GS}=+30\text{V}, V_{DS}=0\text{V}$   |     |      | +100 | nA            |
|  | Reverse                  |  |     |      | -100 | nA            |
| <b>ON CHARACTERISTICS</b>                              |                          |  |     |      |      |               |
| Gate Threshold Voltage                                 | $V_{GS(\text{TH})}$      | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$  | 2.5 |      | 4.5  | V             |
| Static Drain-Source On-State Resistance                | $R_{DS(\text{ON})}$      | $V_{GS}=10\text{V}, I_D=15\text{A}$  |     |      | 0.15 | $\Omega$      |
| <b>DYNAMIC PARAMETERS</b>                              |                          |  |     |      |      |               |
| Input Capacitance                                      | $C_{\text{ISS}}$         | $V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$                           |     | 2580 |      | pF            |
| Output Capacitance                                     | $C_{\text{OSS}}$         |  |     | 1750 |      | pF            |
| Reverse Transfer Capacitance                           | $C_{\text{RSS}}$         |  |     | 130  |      | pF            |
| <b>SWITCHING PARAMETERS</b>                            |                          |  |     |      |      |               |
| Total Gate Charge (Note 1)                             | $Q_G$                    | $V_{DS}=520\text{V}, V_{GS}=10\text{V}, I_D=30\text{A}$<br>(Note1, 2)            |     | 94   |      | nC            |
| Gate to Source Charge                                  | $Q_{GS}$                 |  |     | 22   |      | nC            |
| Gate to Drain Charge                                   | $Q_{GD}$                 |  |     | 35   |      | nC            |
| Turn-ON Delay Time (Note 1)                            | $t_{D(\text{ON})}$       | $V_{DS}=100\text{V}, V_{GS}=10\text{V}, I_D=30\text{A}, R_G=25\Omega$ (Note1, 2) |     | 34   |      | ns            |
| Rise Time  | $t_R$                    |  |     | 31   |      | ns            |
| Turn-OFF Delay Time                                    | $t_{D(\text{OFF})}$      |  |     | 290  |      | ns            |
| Fall-Time  | $t_F$                    |  |     | 128  |      | ns            |
| <b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b> |                          |  |     |      |      |               |
| Maximum Body-Diode Continuous Current                  | $I_S$                    |  |     |      | 30   | A             |
| Maximum Body-Diode Pulsed Current                      | $I_{SM}$                 |  |     |      | 60   | A             |
| Drain-Source Diode Forward Voltage (Note 1)            | $V_{SD}$                 | $I_S=30\text{A}, V_{GS}=0\text{V}$   |     |      | 1.4  | V             |
| Body Diode Reverse Recovery Time (Note 1)              | $t_{rr}$                 | $I_S=30\text{A}, V_{GS}=0\text{V}, dI_F/dt=100\text{A}/\mu\text{s}$              |     | 232  |      | ns            |
| Body Diode Reverse Recovery Charge                     | $Q_{rr}$                 |  |     | 2.1  |      | $\mu\text{C}$ |

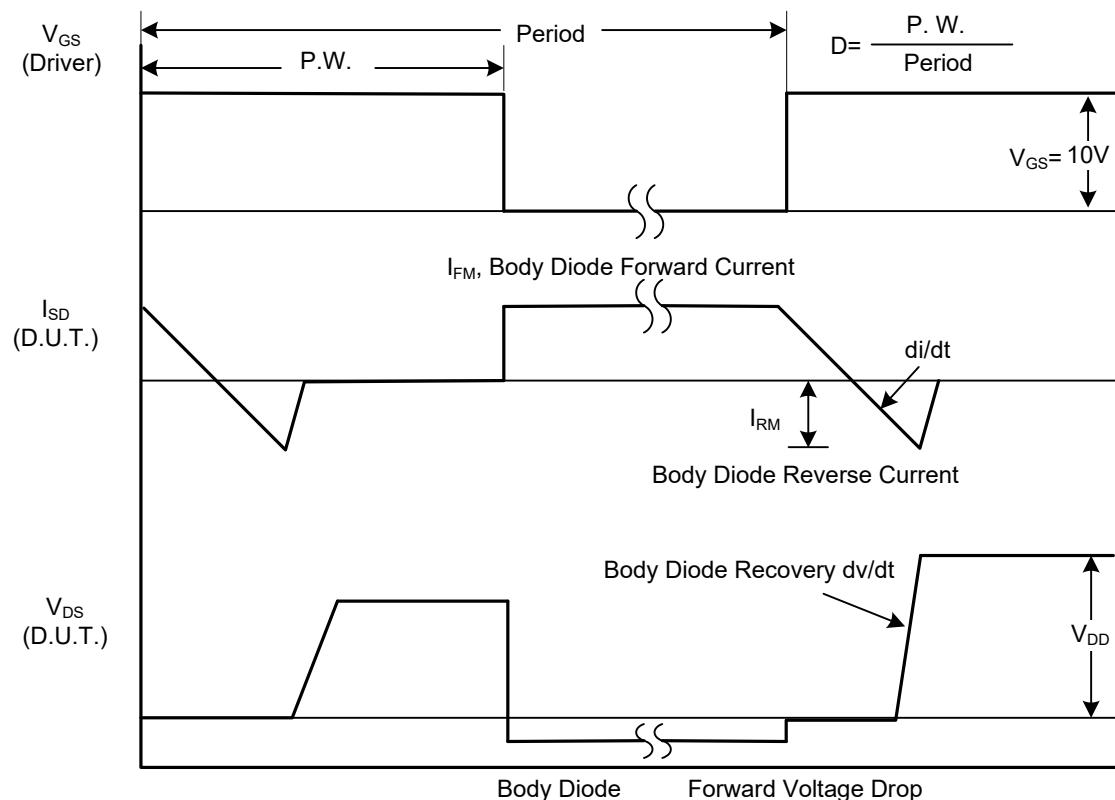
Notes: 1. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS

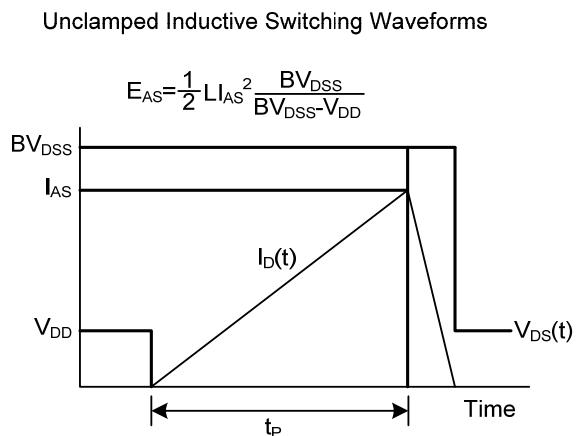
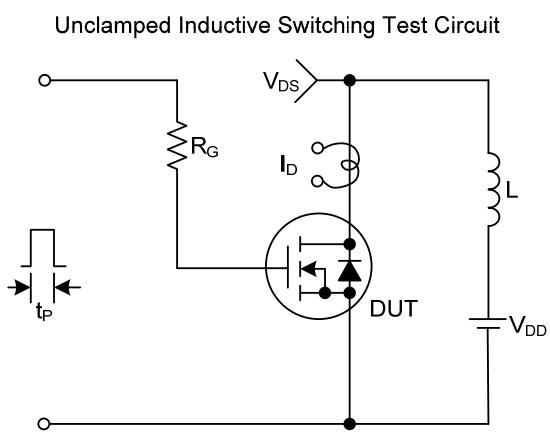
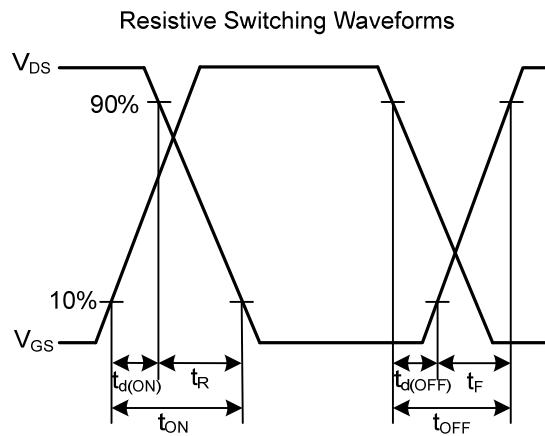
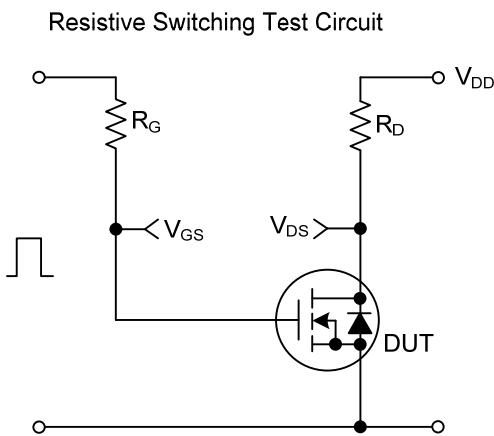
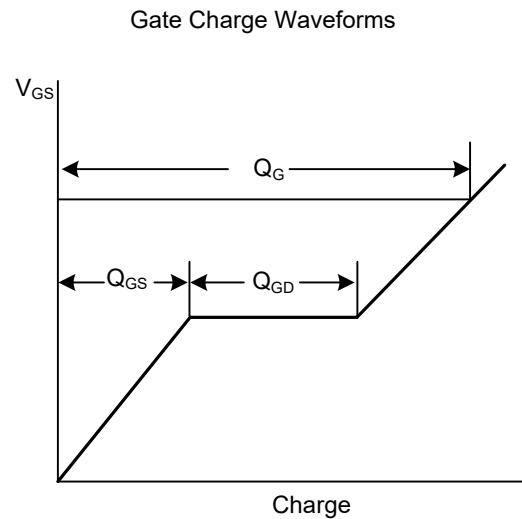
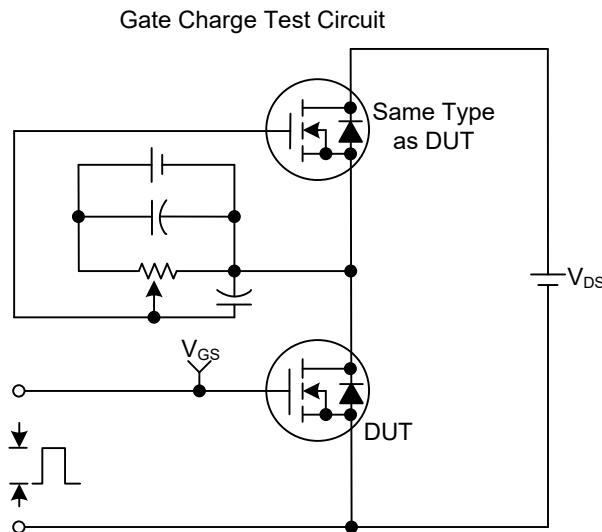


Peak Diode Recovery dv/dt Test Circuit

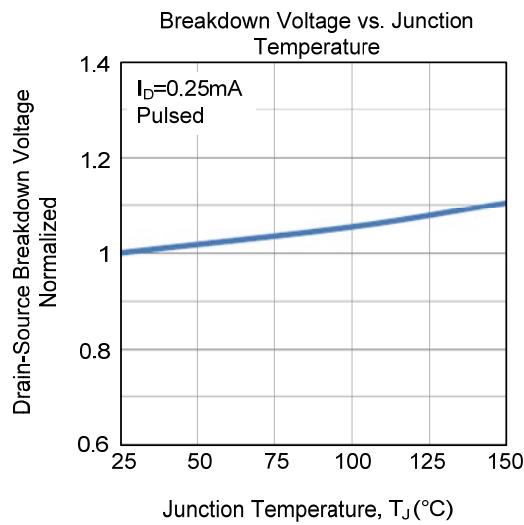
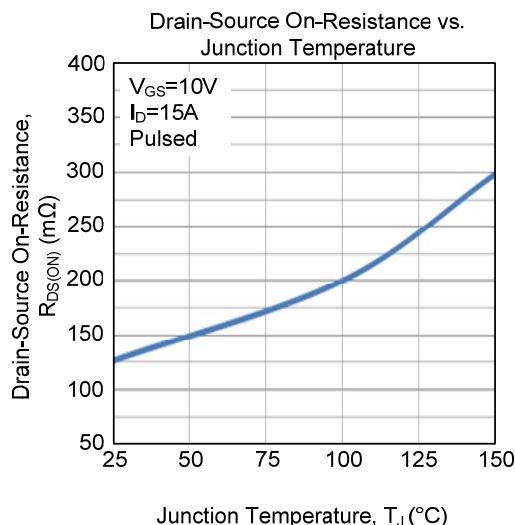
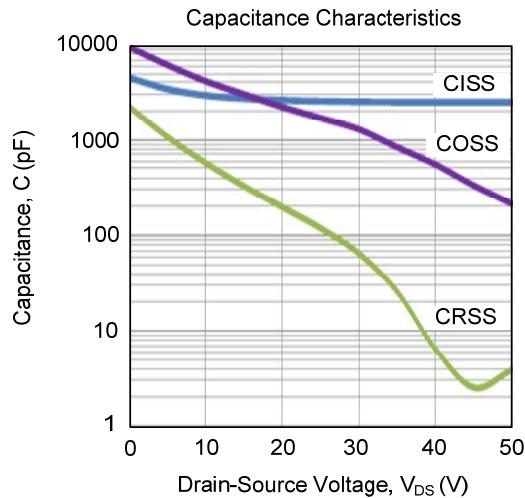
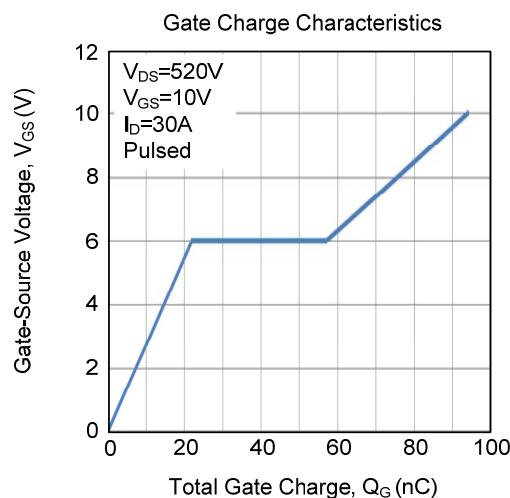
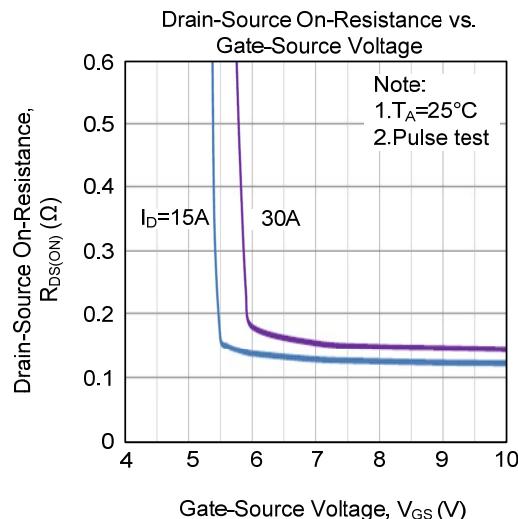
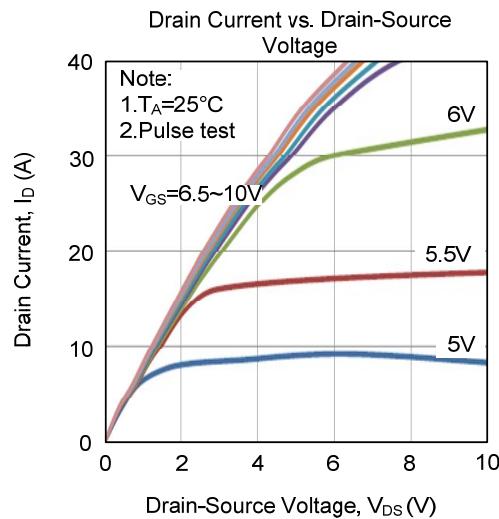


Peak Diode Recovery dv/dt Waveforms

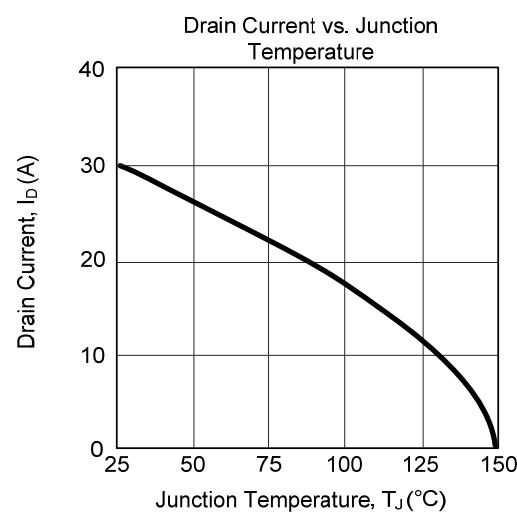
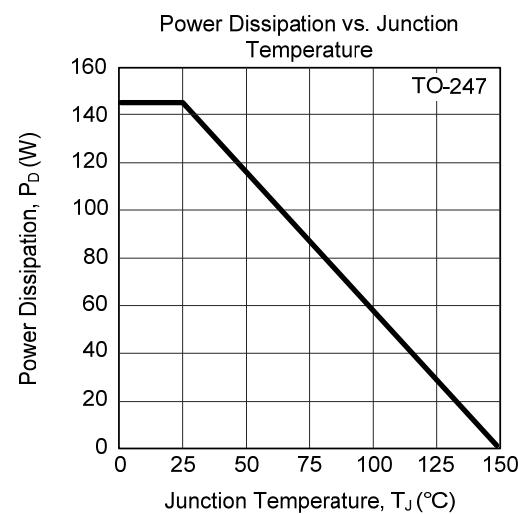
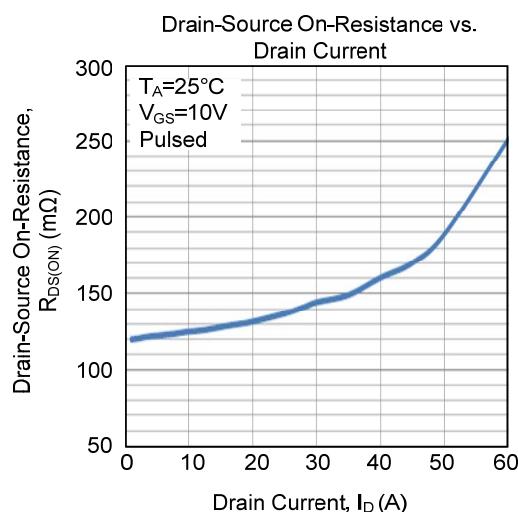
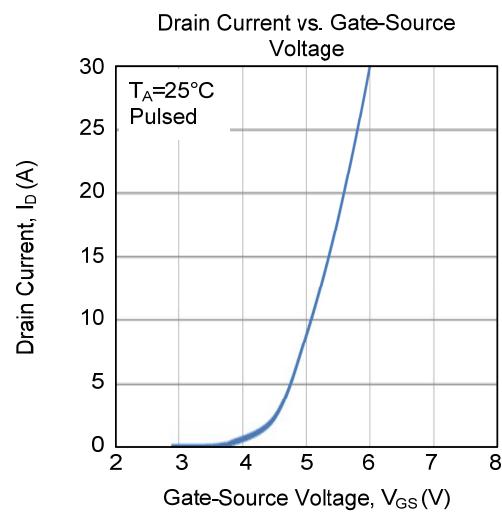
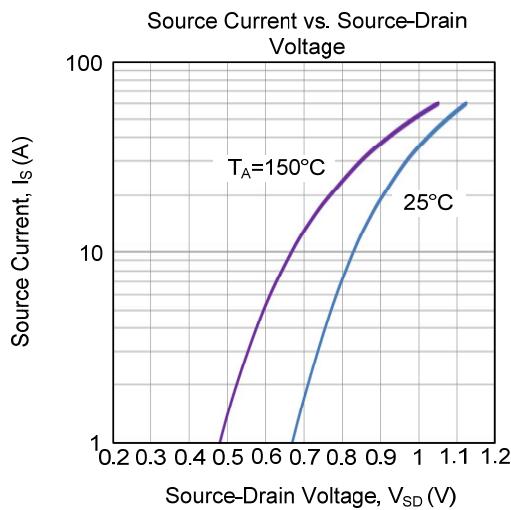
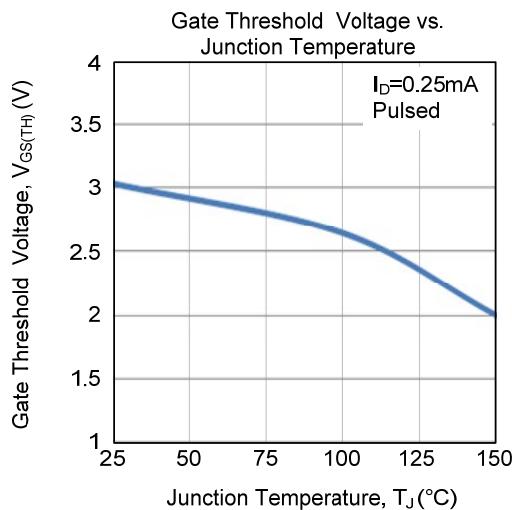
### ■ TEST CIRCUITS AND WAVEFORMS

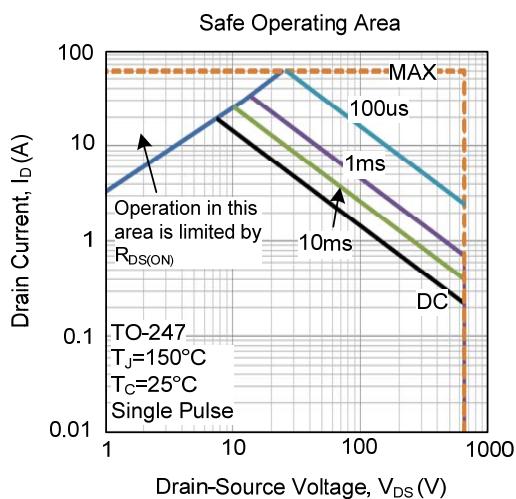


■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



**■ TYPICAL CHARACTERISTICS (Cont.)**

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